

Structure : Silicon Monolithic Integrated Circuit

Product Series : Audio Sound Processor for TV

Type : **BD3888FS** 

Package : SSOP – A32

#### Feature

1) I2C BUS control with the control voltage 3.3V-5.0V

2) Use the Bi-CMOS process

3) Built in 3 input selector

## ● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limit	Unit	
Power supply voltage	VCC	10.0	V	
Intput voltage	VIN	VCC+0.3 $\sim$ GND-0.3	V	
Power dissipation	Pd	1190 *1	mW	
Storage temperature range	Tastg	-55 ∼ +150	°C	

<sup>\*1</sup> At Ta=25°C or higher, this value is decreaced to 9.5mW/°C.

When Rohm standard board is mounted. Thermal resistance  $\theta$ ja = 105 (°C/W).

Rohm standard board: size:  $70 \times 70 \times 1.6 \text{ (mm}^3\text{)}$ 

material: FR4 glass-epoxy substrate (copper foil area: not more than 3%).

## Operating Range

Parameter	Symbol	Min.	Тур.	Max.	Unit
Power supply voltage	VCC	7.0	9.0	9.5	V
Temperture	Topr	-40	-	+85	°C

Design against radiation-proof isn't made



## Function

Function	Specifications			
AGC	4 step suppression level variable			
Front volume	0dB to -87dB (1dB step), -∞dB			
Surround	Stereo Surround			
Bass	±14dB (2dB step)			
Treble ±14dB (2dB step)				
Rear volume	0dB ~-20dB (2dB step), -25dB, -30dB, -45dB, -60dB, -∞dB (Independent control of 1ch/2ch is possible.)			

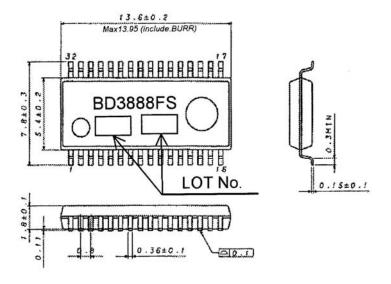
# **•**Electrical Characteristics

Unless specified: Ta=25°C, VCC=9V, f=1kHz, VIN=1Vrms, Rg=600  $\Omega$ , RL=10k  $\Omega$ , Front Volume 0dB, Rear Volume =0dB, Bass=0dB, Treble=0dB, AGC=OFF, SURROUND=OFF.

Davamatas	Symbol	Limits			Unit	Conditions	
Parameter		Min.	Тур.	Max.	Onit	Conditions	
Current upon no signal	IQ	_	8	20	mA	Vin=0Vrms	
Maximum input voltage	VIM	2.6	2.8	_	Vrms	Front Volume = -6dB THD(Vout)=1% BPF=400-30KHz	
Maximum output voltage	Vом	2.2	2.5	_	Vrms	THD=1% BPF=400-30KHz	
Voltage gain	Gv	-2	0	2	dB	G <sub>V</sub> =20log(Vout/Vin)	
Channel balance	СВ	-1.5	0	1.5	dB	CB = GV1-GV2	
Total harmonic distortion	THD+N	_	0.008	0.1	%	Vout=500mVrms BPF=400-30KHz	
Output noise voltage	VNO	-	6	18	μVrms	BPF = IHF-A, Rg=0Ω	
Residual noise voltage	VNOR	-	1.5	10	μVrms	Front Volume = -87dB Rear Volume = -∞dB BPF = IHF-A, Rg=0 Ω	
Cross talk	СТ	70	80	-	dB	CT = 20log(Vout2/Vout1) BPF = IHF-A	



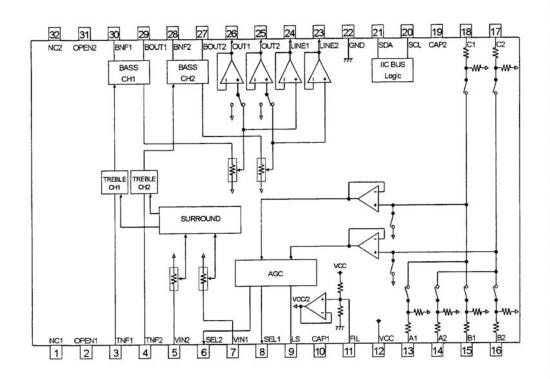
# Dimensional outline drawing



SSOP-A32 (Unit: mm)

## ●Terminal No. / Terminal Name

## Block diagram



Terminal	Terminal			
No.	Name			
1	NC1			
2	OPEN1			
3	TNF1			
4	TNF2			
5	VIN2			
6	SEL2			
7	VIN1			
8	SEL1			
9	LS			
10	CAP1			
11	FIL			
12	VCC			
13	A1			
14	A2			
15	B1			
16	B2			
17	C2			
18	C1			
19	CAP2			
20	SCL			
21	SDA			
22	GND			
23	LINE2			
24	LINE1			
25	OUT2			
26	OUT1			
27	BOUT2			
28	BNF2			
29	BOUT1			
30	BNF1			
31	OPEN2			
32	NC2			



#### Caution on use

- (1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- (2) Absolute maximum ratings If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you think of a case in which absolute maximum ratings are exceeded, enforce fuses or other physical safety measures
- and investigate how not to apply the conditions under which absolute maximum ratings are exceeded to the LSI.

  (3) GND potential

  Make the GND pin voltage such that it is the lowest voltage even when operating below it. Actually confirm that the voltage of each pin does not become a lower voltage than the GND pin, including transient phenomena.
- (4) Thermal design
  Perform thermal design in which there are adequate margins by taking into account the allowable power dissipation in actual states of use.
- (5) Shorts between pins and misinstallation

  When mounting the LSI on a board, pay adequate attention to orientation and placement discrepancies of the

  LSI. If it is misinstalled and the power is turned on, the LSI may be damaged. It also may be damaged if it is
  shorted by a foreign substance coming between pins of the LSI or between a pin and a power supply or a pin
  and a GND.
- (6) Operation in strong magnetic fields

  Adequately evaluate use in a strong magnetic field, since there is a possibility of malfunction.

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